

# RL201G THRU RL207G

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# RL201G THRU RL207G

## 2.0A Axial Leaded General Purpose Rectifiers - 50V-1000V

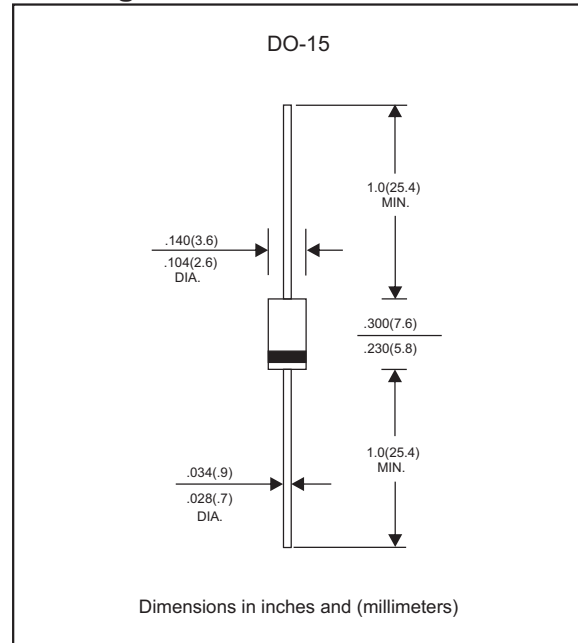
### Features

- Axial lead type devices for through hole design.
- High current capability.
- High surge capability.
- Glass passivation junction chip inside.
- Lead-free parts meet environmental standards of MIL-STD-19500 /228
- Suffix "-H" indicates Halogen-free parts, ex. RL201G-H.

### Mechanical data

- Epoxy : UL94-V0 rated flame retardant
- Case : Molded plastic, DO-15
- Lead : Axial leads, solderable per MIL-STD-202, Method 208 guranteed
- Polarity: Color band denotes cathode end
- Mounting Position : Any
- Weight : Approximated 0.40 gram

### Package outline



### Maximum ratings and Electrical Characteristics (AT $T_A=25^\circ\text{C}$ unless otherwise noted)

| PARAMETER                  | CONDITIONS  | Symbol          | MIN. | TYP. | MAX. | UNIT                      |
|----------------------------|---|-----------------|------|------|------|---------------------------|
| Forward rectified current  | See Fig.1   | $I_O$           |      |      | 2.0  | A                         |
| Forward surge current      | 8.3ms single half sine-wave (JEDEC methode)       | $I_{FSM}$       |      |      | 70   | A                         |
| Reverse current            | $V_R = V_{RRM}$ $T_J = 25^\circ\text{C}$          | $I_R$           |      |      | 5.0  | $\mu\text{A}$             |
|                            | $V_R = V_{RRM}$ $T_J = 125^\circ\text{C}$         |                 |      |      | 50   |                           |
| Thermal resistance         | Junction to ambient                               | $R_{\theta JA}$ |      | 40   |      | $^\circ\text{C}/\text{W}$ |
| Diode junction capacitance | $f=1\text{MHz}$ and applied 4V DC reverse voltage | $C_J$           |      | 20   |      | pF                        |
| Storage temperature        |   | $T_{STG}$       | -65  |      | +175 | $^\circ\text{C}$          |

| SYMBOLS | $V_{RRM}^{*1}$<br>(V) | $V_{RMS}^{*2}$<br>(V) | $V_R^{*3}$<br>(V) | $V_F^{*4}$<br>(V) | Operating temperature<br>$T_J$ , ( $^\circ\text{C}$ ) |
|---------|-----------------------|-----------------------|-------------------|-------------------|---|
| RL201G  | 50                    | 35                    | 50                | 1.10              | -55 to +150   |
| RL202G  | 100                   | 70                    | 100               |                   |   |
| RL203G  | 200                   | 140                   | 200               |                   |   |
| RL204G  | 400                   | 280                   | 400               |                   |   |
| RL205G  | 600                   | 420                   | 600               |                   |   |
| RL206G  | 800                   | 560                   | 800               |                   |   |
| RL207G  | 1000                  | 700                   | 1000              |                   |   |

\*1 Repetitive peak reverse voltage

\*2 RMS voltage

\*3 Continuous reverse voltage

\*4 Maximum forward voltage@ $I_F=2.0\text{A}$

## Rating and characteristic curves (RL201G THRU RL207G)

FIG.1-TYPICAL FORWARD CHARACTERISTICS

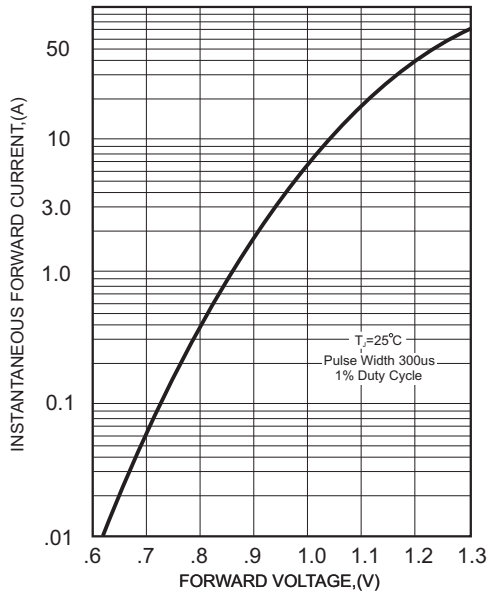


FIG.2-TYPICAL FORWARD CURRENT DERATING CURVE

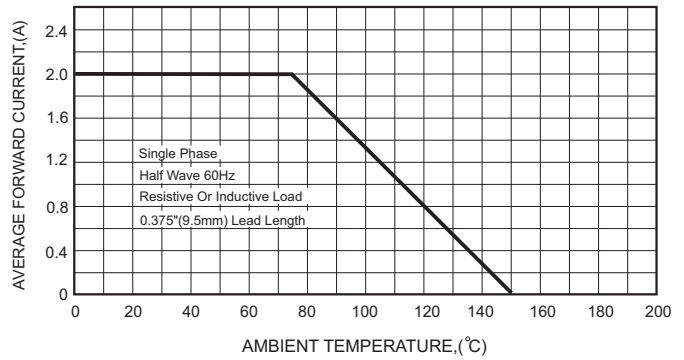


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

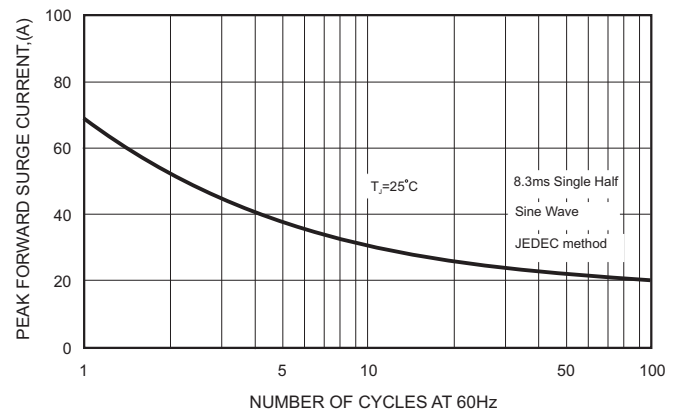


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

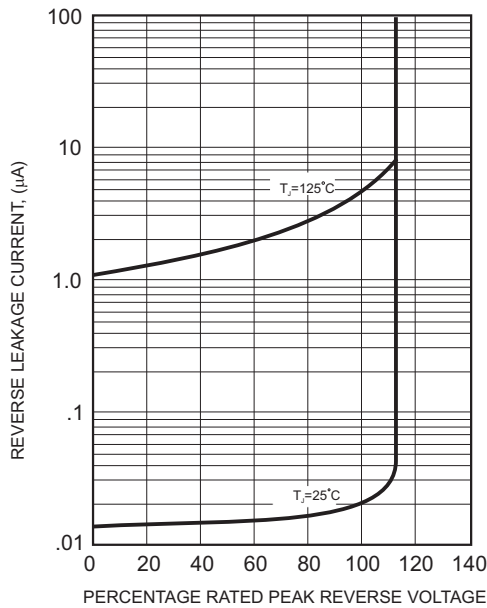
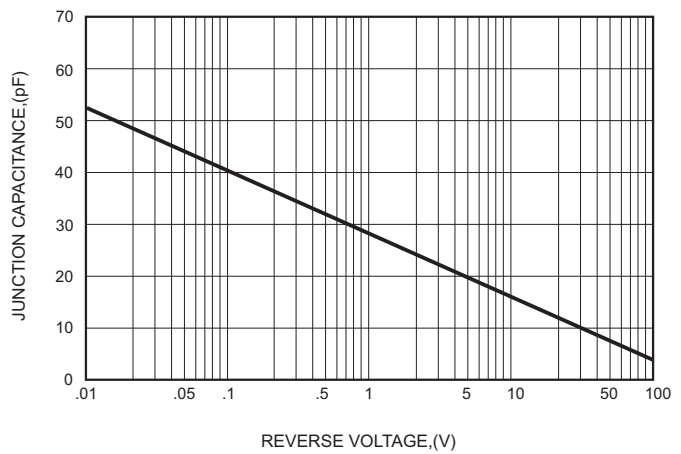




FIG.5-TYPICAL JUNCTION CAPACITANCE



# RL201G THRU RL207G

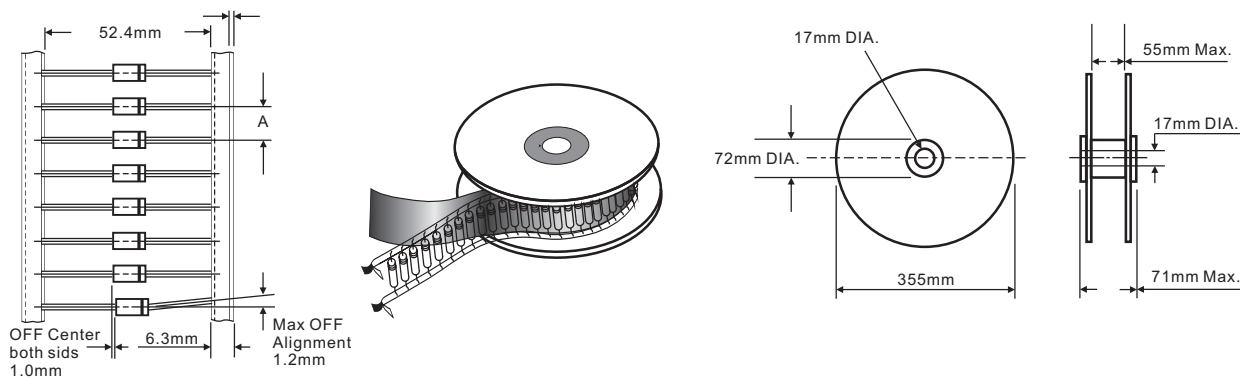
## Pinning information

| Pin                        | Simplified outline   | Symbol  |
|----------------------------|--|---|
| Pin1 cathode<br>Pin2 anode |  |  |

## Marking

| Type number | Marking code |
|-------------|--------------|
| RL201G      | RL201G       |
| RL202G      | RL202G       |
| RL203G      | RL203G       |
| RL204G      | RL204G       |
| RL205G      | RL205G       |
| RL206G      | RL206G       |
| RL207G      | RL207G       |

## Taping & bulk specifications for AXIAL devices



### REEL PACKING

| DEVICE CASE TYPE | Q'TY 1 (PCS / REEL) | COMPONENT SPACING "A" in FIG. A | CARTON SIZE (m/m) | Q'TY 2 (PCS / CARTON) | APPROX. CROSS WEIGHT(kg) |
|------------------|---------------------|---------------------------------|-------------------|-----------------------|--------------------------|
| DO-15            | 4,000               | 5 mm                            | 360 * 340 * 370   | 16,000                | 9.9                      |

### AMMO PACKING

| DEVICE CASE TYPE | Q'TY 1 (PCS / BOX) | INNER BOX SIZE (m/m) | CARTON SIZE (m/m) | Q'TY 2 (PCS / CARTON) | APPROX. CROSS WEIGHT(kg) |
|------------------|--------------------|----------------------|-------------------|-----------------------|--------------------------|
| DO-15            | 3,000              | 260 * 83 * 160       | 440 * 270 * 340   | 30,000                | 14.3                     |

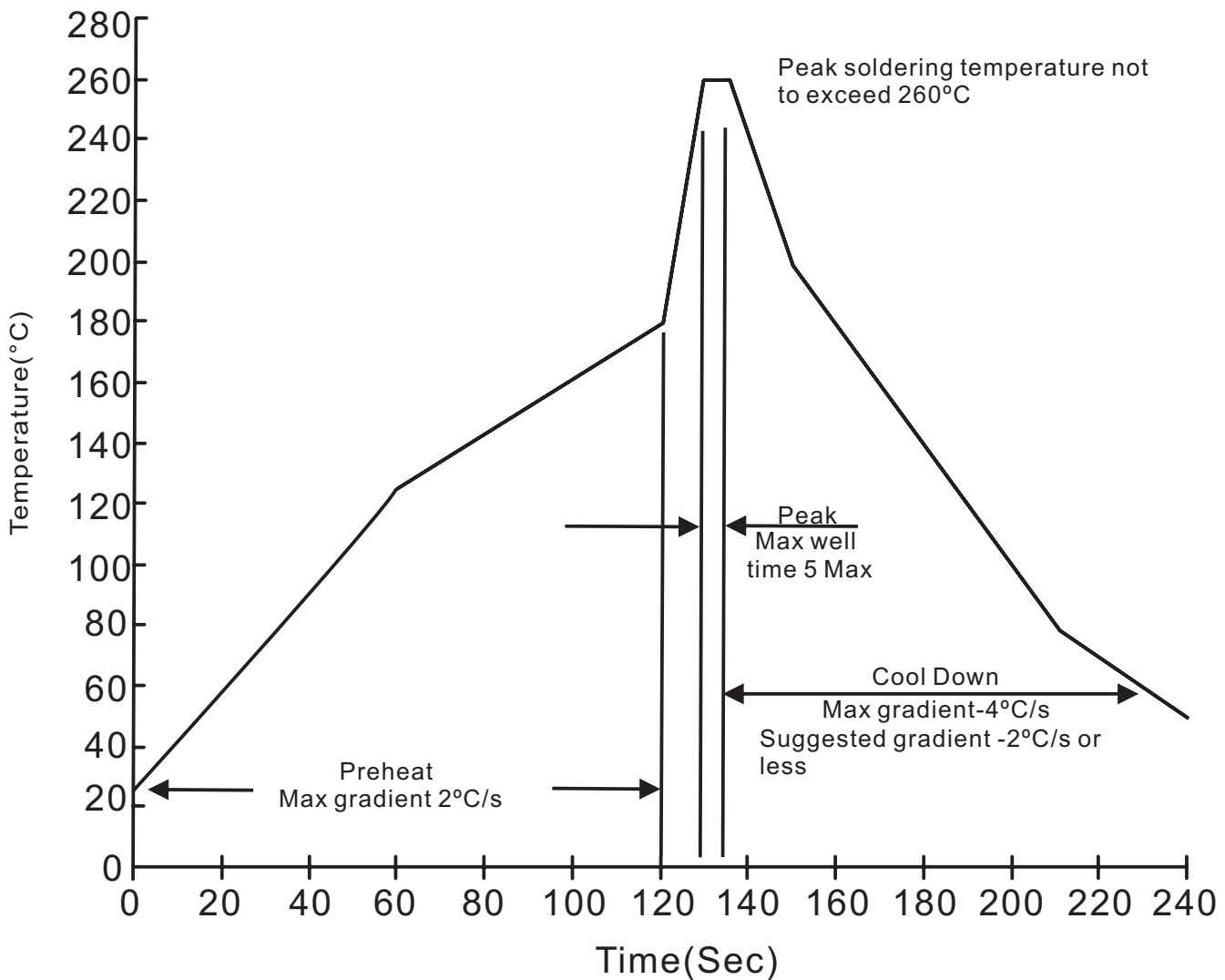
# RL201G THRU RL207G

**BULK PACKING**

| DEVICE CASE TYPE | Q'TY 1 (PCS / BOX) | INNER BOX SIZE (m/m) | CARTON SIZE (m/m) | Q'TY 2 (PCS / CARTON) | APPROX. CROSS WEIGHT(kg) |
|------------------|--------------------|----------------------|-------------------|-----------------------|--------------------------|
| DO-15            | 500                | 194 * 84 * 20        | 465 * 220 * 260   | 25,000                | 12.9                     |

**Suggested thermal profiles for soldering processes**

**1. Lead free temperature profile wave-soldering**



**RL201G THRU RL207G****High reliability test capabilities**

| Item Test                         | Conditions   | Reference                     |
|-----------------------------------|--|-------------------------------|
| 1. Solder Resistance              | at 260±5°C for 10±2sec.<br>immerse body into solder 1/16"±1/32"  | MIL-STD-750D<br>METHOD-2031   |
| 2. Solderability                  | at 245±5°C for 5 sec.  | MIL-STD-202F<br>METHOD-208    |
| 3. Pull Test                      | 1.0kg in axial lead direction for 10 sec.<br>$I_F = I_O$   | MIL-STD-202F<br>METHOD-211A   |
| 4. Bend Lead                      | 1.0kg weight applied to each lead bending<br>arc 90°±5° for 3 times  | MIL-STD-202F<br>METHOD-211A   |
| 5. High Temperature Reverse Bias  | $V_R = 80\%$ rate at $T_J = 150^\circ\text{C}$ for 168 hrs.  | MIL-STD-750D<br>METHOD-1038   |
| 6. Forward Operation Life         | Rated average rectifier current at $T_A = 25^\circ\text{C}$ for 500hrs.  | MIL-STD-750D<br>METHOD-1027   |
| 7. Intermittent Operation Life    | $T_A = 25^\circ\text{C}$ , $I_F = I_O$<br>On state: power on for 5 min.<br>off state: power off for 5 min,<br>on and off for 500 cycles. | MIL-STD-750D<br>METHOD-1036   |
| 8. Pressure Cooker                | 15P <sub>SI6</sub> at $T_A = 121^\circ\text{C}$ for 4 hrs.   | JESD22-A102                   |
| 9. Temperature Cycling            | -55°C to +125°C dwelled for 30 min.<br>and transferred for 5min. total 10 cycles.  | MIL-STD-750D<br>METHOD-1051   |
| 10. Forward Surge                 | 8.3ms single half sine-wave , one surge.   | MIL-STD-750D<br>METHOD-4066-2 |
| 11. Humidity                      | at $T_A = 85^\circ\text{C}$ , RH=85% for 1000hrs.  | MIL-STD-750D<br>METHOD-1021   |
| 12. High Temperature Storage Life | at 175°C for 1000 hrs.   | MIL-STD-750D<br>METHOD-1031   |